SiJ494DP

RoHS

COMPLIANT HALOGEN

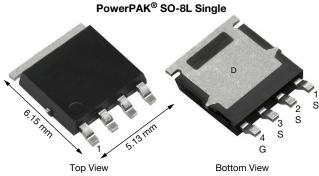
FREE

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Vishay Siliconix

N-Channel 150 V (D-S) MOSFET

PRODU	CT SUMMARY		
V _{DS} (V)	R_{DS(on)} (Ω) Max.	I _D (A) ^a	Q _g (Typ.)
150	0.0232 at V _{GS} = 10 V	36.8	16.1 nC
130	0.0272 at V _{GS} = 7.5 V	34	10.1110



Ordering Information:

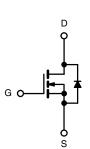
SiJ494DP-T1-GE3 (lead (Pb)-free and halogen-free)

FEATURES

- ThunderFET[®] technology optimizes balance of $R_{DS(on)}$, Q_g , Q_{sw} and Q_{oss}
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Primary side switching
- Synchronous rectification
- DC/AC inverters
- LED backlighting
- High current switching



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unless	otherwise noted	(k		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	150	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		36.8		
Continuous Drain Current (T. 150 °C)	T _C = 70 °C		29.5		
Continuous Drain Current ($T_J = 150 \ ^\circ C$)	T _A = 25 °C	I _D	9.8 ^{b, c}		
	T _A = 70 °C		7.9 ^{b, c}	•	
Pulsed Drain Current (t = 100 μs)		I _{DM}	100	— A	
Constinueuro Courses Ducia Dia da Current	T _C = 25 °C		36.8		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	4.5 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	30		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	45	mJ	
	T _C = 25 °C		69.4		
Maximum Davies Disais atian	T _C = 70 °C		44.4	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	5 ^{b, c}		
	T _A = 70 °C		3.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	•••	
Soldering Recommendations (Peak Temperature) d, e			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.3	1.8	0/00

Notes

- a. T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 65 °C/W.

S16-1734-Rev. A, 29-Aug-16

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SiJ494DP

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static					•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	150	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	111	-	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-7	-	mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5	-	4.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
	I _{DSS}	$V_{DS} = 150 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero Gate Voltage Drain Current		$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	-	-	10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30	-	-	Α
		V _{GS} = 10 V, I _D = 15 A	-	0.0193	0.0232	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0217	0.0272	Ω
Forward Transconductance ^a	g _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	25	-	S
Dynamic ^b					•	
Input Capacitance	C _{iss}		-	1070	-	pF
Output Capacitance	C _{oss}	$V_{DS} = 75 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	250	-	
Reverse Transfer Capacitance	C _{rss}		-	22	-	
	Qg	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	20.3	31	nC
Total Gate Charge			-	16.1	25	
Gate-Source Charge	Q _{gs}	V_{DS} = 75 V, V_{GS} = 7.5 V, I_{D} = 15 A	-	5.5	-	
Gate-Drain Charge	Q _{gd}		-	6.7	-	
Output Charge	Q _{oss}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$	-	50	80	
Gate Resistance	R _g	f = 1 MHz	0.4	1.1	2	Ω
Turn-On Delay Time	t _{d(on)}		-	8	16	
Rise Time	t _r	$V_{DD} = 75 \text{ V}, \text{ R}_{L} = 5 \Omega$	-	18	36	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 15 A, V_{GEN} = 10 V, R_g = 1 Ω	-	15	30	
Fall Time	t _f		-	8	16	
Turn-On Delay Time	t _{d(on)}		-	11	22	ns
Rise Time	t _r	$V_{DD} = 75 \text{ V}, \text{ R}_{\text{L}} = 5 \Omega$	-	58	115	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 15$ Å, $V_{GEN} = 7.5$ V, $R_g = 1$ Ω	-	12	24	
Fall Time	t _f		-	22	44	
Drain-Source Body Diode Characteristic	s				•	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	36.8	A
Pulse Diode Forward Current (t = $100 \ \mu s$)	I _{SM}		-	-	100	
Body Diode Voltage	V _{SD}	I _S = 5 A	-	0.79	1.1	V
Body Diode Reverse Recovery Time	t _{rr}		-	103	206	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	370	740	nC
Reverse Recovery Fall Time	t _a	$I_F = 15 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 ^\circ\text{C}$	-	68	-	
Reverse Recovery Rise Time	t _b		-	35	-	ns

Notes

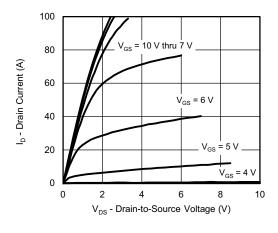
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

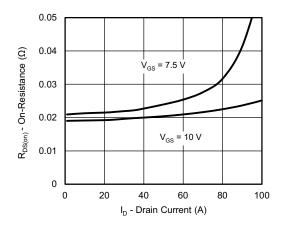
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



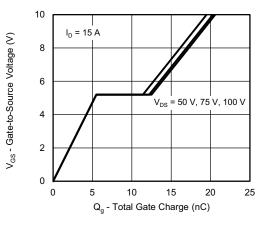
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



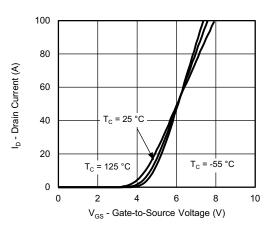
Output Characteristics



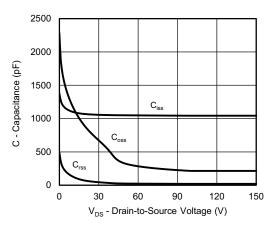
On-Resistance vs. Drain Current



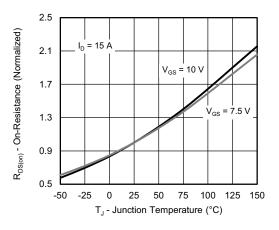
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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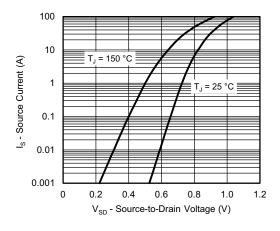
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Document Number: 79056

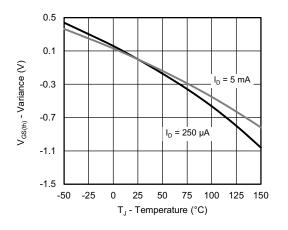
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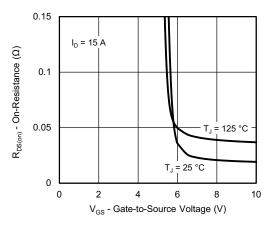
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



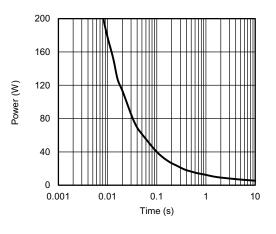
Source-Drain Diode Forward Voltage



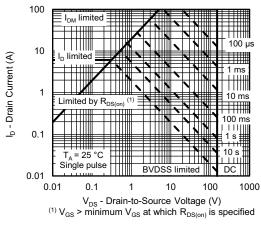
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



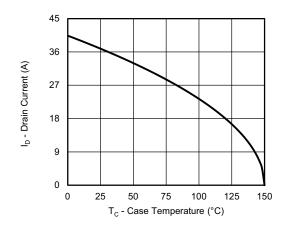
Safe Operating Area, Junction-to-Ambient

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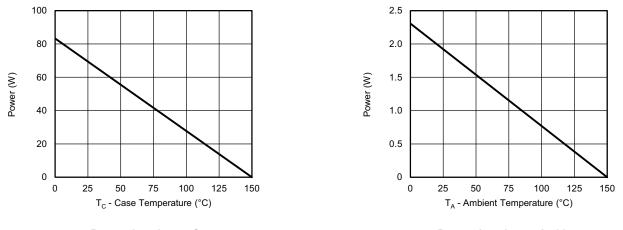
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power, Junction-to-Case

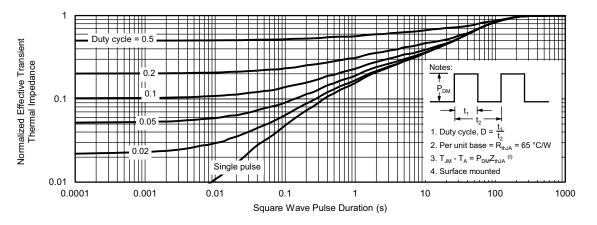
Power, Junction-to-Ambient

Note

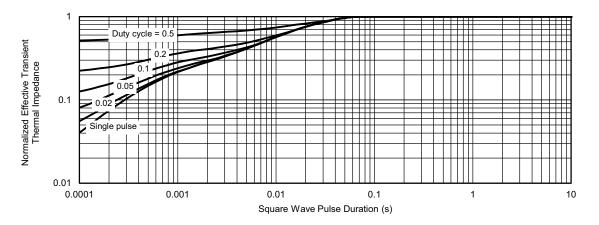
a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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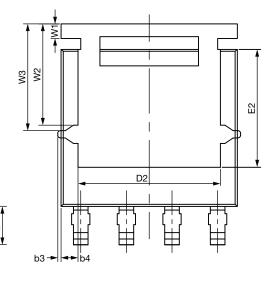


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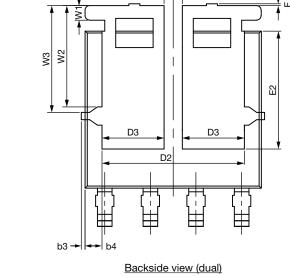
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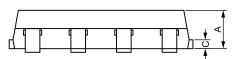




Topside view

Backside view (single)





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Package Information



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DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094			0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC		0.050 BSC				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	3.18	3.28	3.38	0.125	0.129	0.133		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
К	0.51			0.020				
W		0.23			0.009			
W1	0.41			0.016				
W2	2.82			0.111				
W3	2.96			0.117				
θ	0°	-	10°	0°	-	10°		

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



Vishay

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